

## 16V P-Channel Enhancement-Mode MOSFET

**V<sub>DS</sub> = -16V**

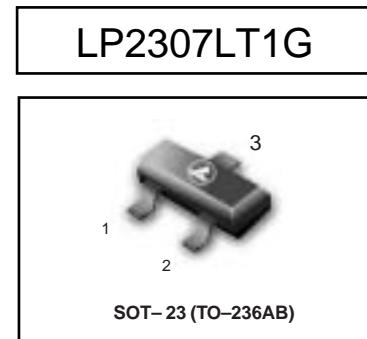
**R<sub>DSON</sub>, V<sub>GS</sub>@-4.5V, I<sub>DS</sub>@-4.7A = 60 mΩ**

**R<sub>DSON</sub>, V<sub>GS</sub>@-2.5V, I<sub>DS</sub>@-1.0A = 100 mΩ**

### Features

Advanced trench process technology

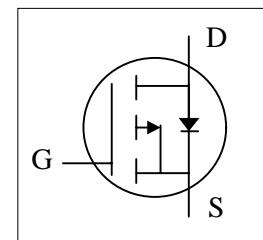
High Density Cell Design For Ultra Low On-Resistance



▼ Simple Drive Requirement

▼ Small Package Outline

▼ Surface Mount Device



### ORDERING INFORMATION

| Device     | Marking | Shipping        |
|------------|---------|-----------------|
| LP2307LT1G | P07     | 3000/Tape&Reel  |
| LP2307LT3G | P07     | 10000/Tape&Reel |

### Absolute Maximum Ratings

| Symbol                               | Parameter                             | Rating     | Units |
|--------------------------------------|---------------------------------------|------------|-------|
| V <sub>DS</sub>                      | Drain-Source Voltage                  | -16        | V     |
| V <sub>GS</sub>                      | Gate-Source Voltage                   | ±8         | V     |
| I <sub>D</sub> @T <sub>A</sub> =25°C | Continuous Drain Current <sup>3</sup> | -4.7       | A     |
| I <sub>D</sub> @T <sub>A</sub> =70°C | Continuous Drain Current <sup>3</sup> | -3.3       | A     |
| I <sub>DM</sub>                      | Pulsed Drain Current <sup>1</sup>     | -20        | A     |
| P <sub>D</sub> @T <sub>A</sub> =25°C | Total Power Dissipation               | 1.1        | W     |
| P <sub>D</sub> @T <sub>A</sub> =70°C | Total Power Dissipation               | 0.7        | W     |
| T <sub>STG</sub>                     | Storage Temperature Range             | -55 to 150 | °C    |
| T <sub>J</sub>                       | Operating Junction Temperature Range  | -55 to 150 | °C    |

### Thermal Data

| Symbol             | Parameter  | Value | Unit |
|--------------------|--|-------|------|
| R <sub>thj-a</sub> | Thermal Resistance Junction-ambient <sup>3</sup> | 110   | °C/W |

**LP2307LT1G**
**Electrical Characteristics@ $T_j=25^\circ\text{C}$ (unless otherwise specified)**

| Symbol                   | Parameter   | Test Conditions  | Min. | Typ.  | Max.      | Units            |
|--------------------------|---|--|------|-------|-----------|------------------|
| $\text{BV}_{\text{DSS}}$ | Drain-Source Breakdown Voltage                          | $V_{\text{GS}}=0\text{V}$ , $I_{\text{D}}=-250\mu\text{A}$     | -16  | -     | -         | V                |
| $R_{\text{DS(ON)}}$      | Static Drain-Source On-Resistance <sup>2</sup>          | $V_{\text{GS}}=-4.5\text{V}$ , $I_{\text{D}}=-4.7\text{A}$     | -    | 48    | 60        | $\text{m}\Omega$ |
|                          |   | $V_{\text{GS}}=-2.7\text{V}$ , $I_{\text{D}}=-3.8\text{A}$     | -    | 63    | 90        | $\text{m}\Omega$ |
|                          |   | $V_{\text{GS}}=-2.5\text{V}$ , $I_{\text{D}}=-1.0\text{A}$     | -    | 65    | 100       | $\text{m}\Omega$ |
| $V_{\text{GS(th)}}$      | Gate Threshold Voltage                                  | $V_{\text{DS}}=V_{\text{GS}}$ , $I_{\text{D}}=-250\mu\text{A}$ | -0.6 | -0.85 | -1.4      | V                |
| $g_{\text{fs}}$          | Forward Transconductance                                | $V_{\text{DS}}=-10\text{V}$ , $I_{\text{D}}=-4.7\text{A}$      | -    | 8     | -         | S                |
| $I_{\text{DSS}}$         | Drain-Source Leakage Current ( $T_j=25^\circ\text{C}$ ) | $V_{\text{DS}}=-16\text{V}$ , $V_{\text{GS}}=0\text{V}$        | -    | -     | -1        | $\mu\text{A}$    |
| $I_{\text{GSS}}$         | Gate-Source Leakage                                     | $V_{\text{GS}}=\pm 8\text{V}$ , $V_{\text{DS}}=0\text{V}$      | -    | -     | $\pm 100$ | nA               |
| $Q_g$                    | Total Gate Charge <sup>2</sup>                          | $I_{\text{D}}=-4.7\text{A}$                                    | -    | 24    | 36        | nC               |
| $Q_{\text{gs}}$          | Gate-Source Charge                                      |  | -    | 18    | -         | nC               |
| $Q_{\text{gd}}$          | Gate-Drain ("Miller") Charge                            |  | -    | 2.7   | -         | nC               |
| $t_{\text{d(on)}}$       | Turn-on Delay Time <sup>2</sup>                         | $V_{\text{DS}}=-10\text{V}$                                    | -    | 22    | 35        | ns               |
| $t_r$                    | Rise Time   | $I_{\text{D}}=-1\text{A}$                                      | -    | 35    | 55        | ns               |
| $t_{\text{d(off)}}$      | Turn-off Delay Time                                     | $R_G=6\Omega$ , $V_{\text{GS}}=-4.5\text{V}$                   | -    | 45    | 70        | ns               |
| $t_f$                    | Fall Time   | $R_D=10\Omega$   | -    | 25    | 40        | ns               |
| $C_{\text{iss}}$         | Input Capacitance                                       | $V_{\text{GS}}=0\text{V}$                                      | -    | 985   | 1580      | pF               |
| $C_{\text{oss}}$         | Output Capacitance                                      | $V_{\text{DS}}=-15\text{V}$                                    | -    | 180   | -         | pF               |
| $C_{\text{rss}}$         | Reverse Transfer Capacitance                            | $f=1.0\text{MHz}$  | -    | 160   | -         | pF               |

**Source-Drain Diode**

| Symbol          | Parameter                 | Test Conditions                                | Min. | Typ. | Max. | Units |
|-----------------|---------------------------|--|------|------|------|-------|
| $I_s$           | Max Diode Forward Current |  |      |      | -1.7 | A     |
| $V_{\text{SD}}$ | Diode Forward Voltage     | $I_s=-1.7\text{A}$ , $V_{\text{GS}}=0\text{V}$ |      |      | -1.2 | V     |

**Notes:**

- 1.Pulse width limited by Max. junction temperature.
- 2.Pulse width  $\leq 300\mu\text{s}$  , duty cycle  $\leq 2\%$ .
- 3.Surface mounted on 1 in<sup>2</sup> copper pad of FR4 board ;  $270^\circ\text{C}/\text{W}$  when mounted on min. copper pad.

# LP2307LT1G

## TYPICAL ELECTRICAL CHARACTERISTICS

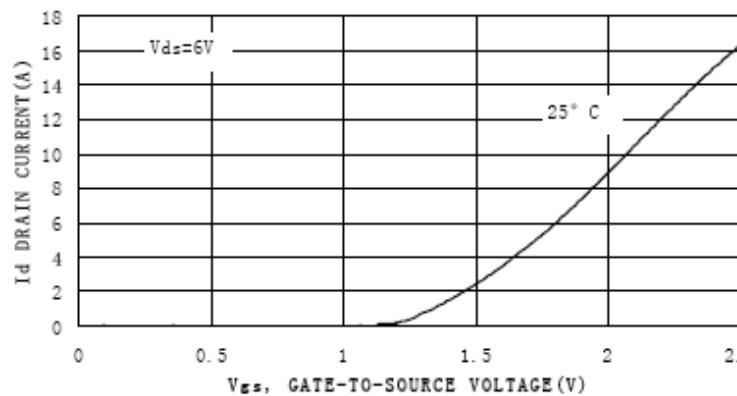


Figure 1. Transfer Characteristics

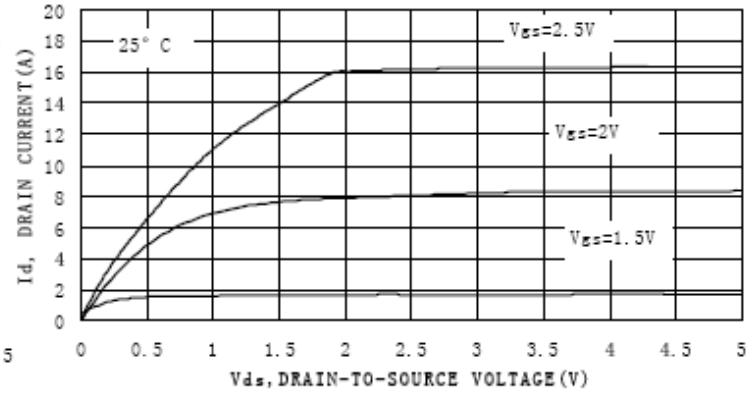


Figure 2. On-Region Characteristics

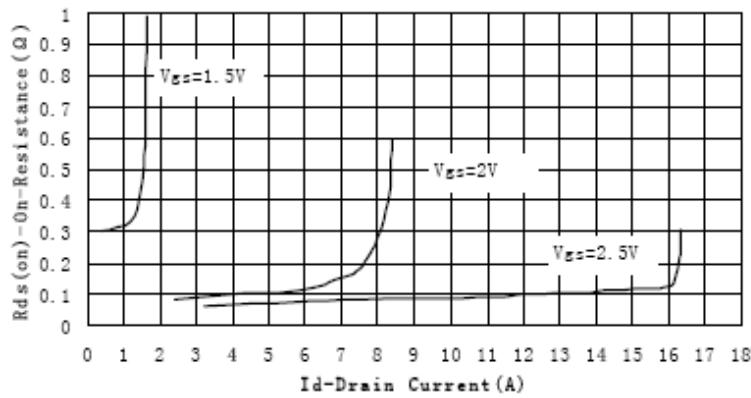


Figure 3. On-Resistance versus Drain Current

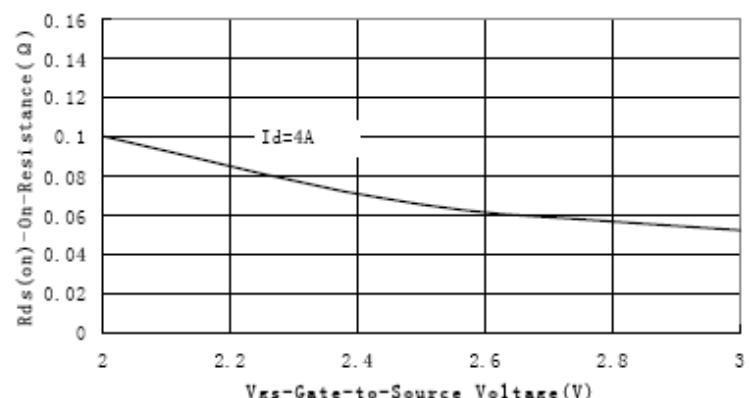
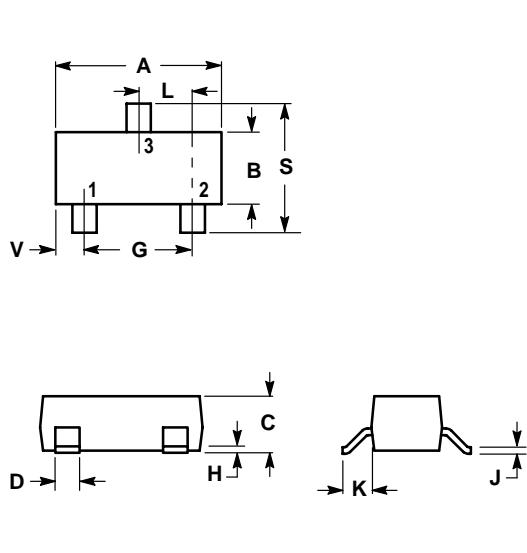


Figure 4. On-Resistance vs. Gate-to-Source Voltage

**LP2307LT1G**
**SOT-23**

**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M,1982
2. CONTROLLING DIMENSION: INCH.

| DIM | INCHES |        | MILLIMETERS |       |
|-----|--------|--------|-------------|-------|
|     | MIN    | MAX    | MIN         | MAX   |
| A   | 0.1102 | 0.1197 | 2.80        | 3.04  |
| B   | 0.0472 | 0.0551 | 1.20        | 1.40  |
| C   | 0.0350 | 0.0440 | 0.89        | 1.11  |
| D   | 0.0150 | 0.0200 | 0.37        | 0.50  |
| G   | 0.0701 | 0.0807 | 1.78        | 2.04  |
| H   | 0.0005 | 0.0040 | 0.013       | 0.100 |
| J   | 0.0034 | 0.0070 | 0.085       | 0.177 |
| K   | 0.0140 | 0.0285 | 0.35        | 0.69  |
| L   | 0.0350 | 0.0401 | 0.89        | 1.02  |
| S   | 0.0830 | 0.1039 | 2.10        | 2.64  |
| V   | 0.0177 | 0.0236 | 0.45        | 0.60  |

